

CALL FOR PAPERS

Journal of Integrated Enterprise Systems

ISSN: 2168-197X (Print) and 2162-9285 (Online)

Submission Deadline for the Third Issue: July 10, 2017

Target Published Date: August 31, 2017

AIM AND OBJECTIVES

Enterprise systems are an integral part of today's business environment, and addressed in a variety of classroom settings. The purpose of JIES is to provide an outlet to academic and practitioner research that extends the usability of such systems in organizations, as well as in the classroom. JIES invites papers, discipline-based or pedagogy/instructional research, and case studies incorporating enterprise systems into business, accounting, and information systems curricula. Suggested topics include (but are not limited to):

- Accounting Information Systems
- Business Intelligence/Analytics/Big Data
- Business Performance Management
- Cloud Computing
- Curriculum Design Issues
- Customer Relationship Management (CRM)
- Enterprise Resource Planning (ERP)
- Financial Reporting Systems
- Information Audit
- Information Assurance/Security
- Information System Project Management
- Information Systems/Computer Technology
- Systems Analysis and Design
- Supply Chain Management

SUBMISSION FOR REFEREED PAPERS

The full paper submission will undergo a double-blind review process. JIES will be published online. Full paper submission requires the use of Microsoft Office Word format, double-spacing, minimum 11 font size, and no more than 30 pages. Manuscripts should follow APA guidelines for citations and references (See <http://apastyle.apa.org>).

The deadline for online submission is **July 10, 2017**. No hardcopy will be accepted. Authors will receive email notification of acceptance/rejection by **August 8, 2017**. Final revisions of accepted papers for publication in JIES are due **August 20, 2016**.

ONLINE SUBMISSION

Click the following link for online submissions:

<http://J-IES.org> or <http://clcloud.com/JIES>

If you have any problems in submitting your paper, please e-mail it to Dr. Huei Lee, Editor-in-Chief at Huei.Lee@emich.edu and cc to dynaa@microsoft.com